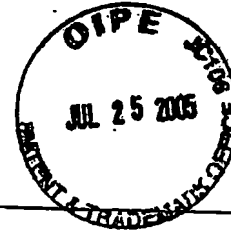


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Title of Invention: METHOD FOR MAKING THIN FILM SEMICONDUCTOR  
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1. Disclaimer in Patent Under 37 CFR 1.321(a) (1 page);
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